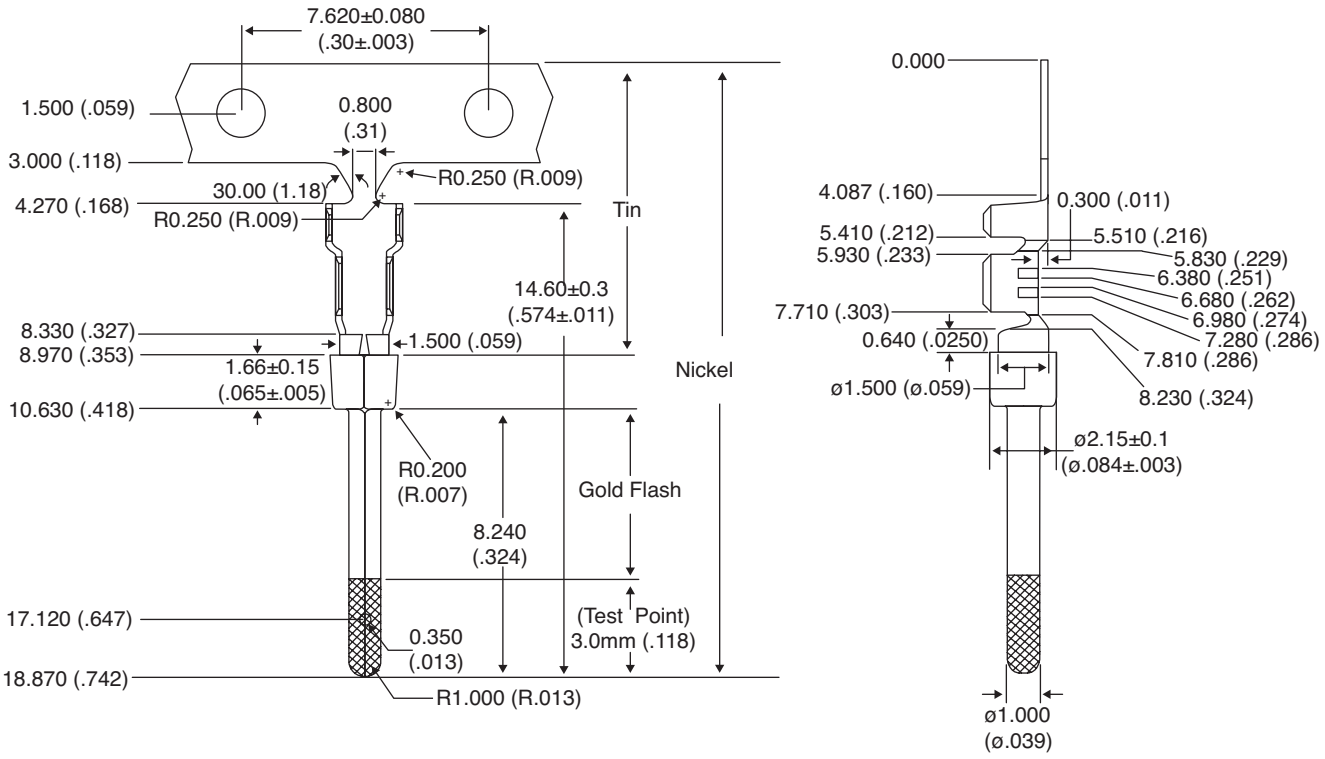
D-Sub Crimp Pin (Male)

156-1402-E

KOBICONN



Dimensions: mm (in.)
(except where noted)

SPECIFICATIONS	
Material:	C2680 HV160°
Thickness:	0.20mm
Underplate:	50μ" Nickel
Contact Area:	1μ"~50μ" Selective Gold
Solder Tails Area:	100μ" Tin/Lead (Brighten Tin) or
	100μ" Tin/Lead Free (Brighten Tin/Matte Tin)
Tolerance:	±0.15mm
Angle Tolerance:	±1.0°
RoHS Compliant	

Date Last Revised: 09-11-07

Available from Mouser Electronics
1-800-346-6873 / www.mouser.com

KC-301176

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